

Designers Data Sheet

HOT CARRIER POWER RECTIFIERS

... employing the Schottky Barrier principle in a large area metalto-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free-wheeling diodes, and polarity-protection diodes.

- Extremely Low vF
- High Surge Capacity
- Low Stored Charge, Majority **Carrier Conduction**
- TX Version Available
- Low Power Loss / High Efficiency

Designer's Data for "Worst Case" Conditions

The Designers Data sheets permit the design of most circuits entirely from the information presented. Limit curves - representing boundaries on device characteristics - are given to facilitate "worst case" design.

*MAXIMUM RATINGS

Rating	Symbol	1N5823	1N5824	1N5825 MBR5825H, H1	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _R WM V _R	20	30	40	Volts
Non-Repetitive Peak Reverse Voltage	VRSM	24	36	48	Volts
RMS Reverse Voltage	VR(RMS)	14	21	28	Volts
Average Rectified Forward Current $V_{R}(equiv) \leq 0.2 V_{R} (dc), T_{C} = 75^{\circ}C$ $V_{R}(equiv) \leq 0.2 V_{R} (dc), T_{L} = 80^{\circ}C$ $R_{\theta}J_{A} = 25^{\circ}C/W, P.C. Board$ Mounting, See Note 3)	10		15 5.0		Amp
Ambient Temperature Rated VR (dc)· PF(AV) = 0 R _{θJA} = 25°C/W	ТА	65	60	55	°C
Non-Repetitive ¹ Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase 60 Hz)	IFSM	500 (for 1 cycle)			Amp
Operating and Storage Junction Temperature Range (Reverse Voltage applied)	Tj, T _{stg}	-65 to +125			°C
Peak Operating Junction Temperature (Forward Current Applied)	T _{J(pk)}	4	150 -		°C

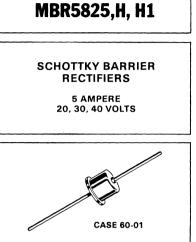
***THERMAL CHARACTERISTICS**

Characteristic	Symbol	Мах	Unit
Thermal Resistance, Junction to Case	R _{∉JC}	3.0	°C/W

*ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Characteristic	Symbol	1N5823	1N5824	1N5825 MBR5825H, H1	Unit
Maximum Instantaneous Forward Voltage (1) (iϝ = 3.0 Amp) (iϝ = 5.0 Amp) (iϝ = 15.7 Amp)	VF	0.330 0.360 0.470	0.340 0.370 0.490	0.350 0.380 0.520	Volts
Maximum Instantaneous Reverse Current @ rated dc Voltage T _C = 25°C T _C = 100°C	iR	10 75	10 75	10 75	mA

(1) Pulse Test: Pulse Width = 300 µs, Duty Cycle = 2.0% *Indicates JEDEC Registered Data for 1N5823-1N5825



1N5823, 1N5824

1N5825

NOTE 1: DETERMINING MAXIMUM RATINGS

Reverse power dissipation and the possibility of thermal runaway must be considered when operating this rectifier at reverse voltages above 0.1 VRWM. Proper derating may be accomplished by use of equation (1)

 $T_A(max) = T_J(max) - R_{\theta,JA} P_F(AV) - R_{\theta,JA} P_B(AV)$ (1)where

TA(max) = Maximum allowable ambient temperature

- T_{J(max)} = Maximum allowable junction temperature (125°C or the temperature at which thermal runaway occurs, whichever is lowest).
- PF(AV) = Average forward power dissipation
- PR(AV) = Average reverse power dissipation
 - $R_{\theta JA} = Junction-to-ambient thermal resistance$

Figures 1, 2 and 3 permit easier use of equation (1) by taking reverse power dissipation and thermal runaway into consideration. The figures solve for a reference temperature as determined by equation (2):

$$T_{R} = T_{J(max)} - R_{\theta JA} P_{R(AV)}$$
(2)

 $T_{A(max)} = T_{R} - R_{\theta JA} P_{F(AV)}$ (3)

Inspection of equations (2) and (3) reveals that T_{R} is the ambient temperature at which thermal runaway occurs or where $T_J = 125^{\circ}C$, when forward power is zero. The transition from one boundary condition to the other is evident on the curves of Figures 1, 2 and

3 as a difference in the rate of change of the slope in the vicinity of 115°C. The data of Figures 1, 2 and 3 is based upon dc conditions For use in common rectifier circuits. Table Lindicates suggested factors for an equivalent dc voltage to use for conservative design: i.e.

VR(equiv) = VIN(PK) × F (4) The Factor F is derived by considering the properties of the various

rectifier circuits and the reverse characteristics of Schottky diodes.

Example: Find TA(max) for 1N5825 operated in a 12-Volt dc supply using a bridge circuit with capacitive filter such that IDC = 10 A ($I_{F}(AV) = 5 A$), I(PK)/I(AV) = 10, Input Voltage = 10 V(rms), $R_{\theta JA} = 10^{\circ}C/W$.

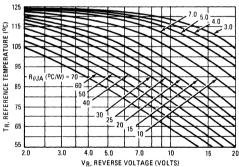
- Find VR(equiv). Read F = 0.65 from Table 1. Step 1: VR(equiv) = (1.41)(10)(0.65) = 9.2 V
- Find T_R from Figure 3. Read T_R = 113 °C @ V_R = Step 2: $9.2 \vee \& R_{\theta JA} = 10^{\circ}C/W.$
- Find PF(AV) from Figure 4.**Read PF(AV) = 5.5 W Step 3: $\frac{1}{1} \frac{(PK)}{PK} = 10 \ \& \ |F(AV) = 5 \ A$ ര്
- I(AV) Find $T_{A(max)}$ from equation (3). $T_{A(max)} = 113-(10)$ (5.5) = 58°C. Step 4:
- ** Value given are for the 1N5825. Power is slightly lower for the other units because of their lower forward voltage.

Circuit	Half Wave		Full Wa	ve, Bridge	Full Wave, Center Tapped *†		
Load	Resistive	Capacitive*	Resistive	Capacitive	Resistive	Capacitive	
Sine Wave	0.5	1.3	0.5	0.65	1.0	1.3	
Square Wave	0.75	1.5	0.75	0.75	1.5	1.5	

TABLE I - VALUES FOR FACTOR F

LOad	1103131146	Capacitive	Inesistive	Capacitive	nesistive	Ĺ.
Sine Wave	0.5	1.3	0.5	0.65	1.0	ſ
Square Wave	0.75	1.5	0.75	0.75	1.5	Ē
*Note that VR(PK) †Use	line to cente	r tap voltage f	or V _{in} .		







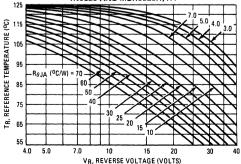


FIGURE 2 - MAXIMUM REFERENCE TEMPERATURE - 1N5824

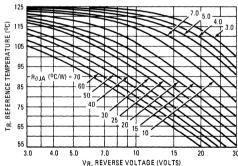
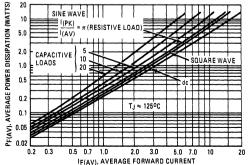
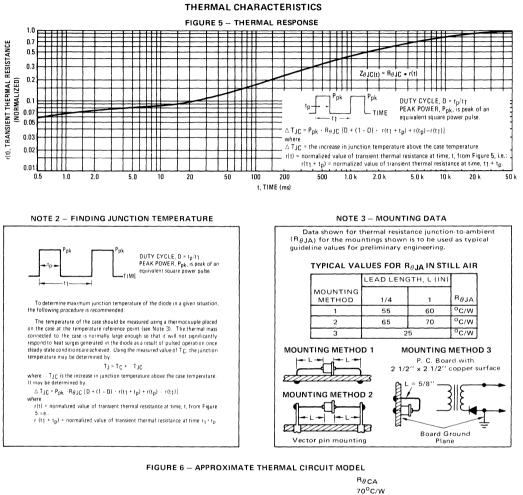
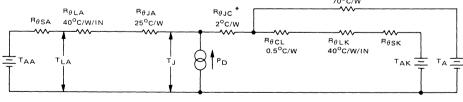


FIGURE 4 -- FORWARD POWER DISSIPATION







Use of the above model permits calculation of average junction temperature for any mounting situation. Lowest values of thermal resistance will occur when the cathode lead is brought as close as possible to a heat dissipator; as heat conduction through the anode lead is small. Terms in the model are defined as follows:

*Case temperature reference

is at cathode end.

TEMPERATURES

- T_A = Ambient
- TAA = Anode Heat Sink Ambient
- T_{AK} = Cathode Heat Sink Ambient
- T_{LA} = Anode Lead
- T_{LK} = Cathode Lead
- T_J = Junction

THERMAL RESISTANCES

- $R_{\theta CA} = Case to Ambient$
- Resa = Anode Lead Heat Sink to Ambient $R_{\theta SK}$ = Cathode Lead Heat Sink to Ambient $R_{\theta LA}$ = Anode Lead

- $R_{\theta LK} = Cathode Lead$
- $R_{\theta}CL = Case to Cathode Lead$ $R_{\theta}JC = Junction to Case$
- $R_{\theta JA}$ = Junction to Anode Lead (S bend)

FIGURE 7 - TYPICAL FORWARD VOLTAGE

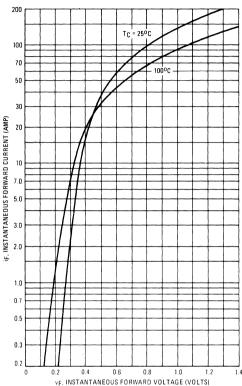


FIGURE 10 - CAPACITANCE

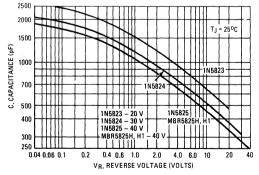
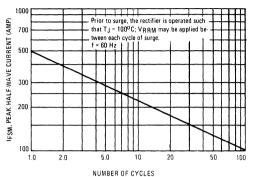
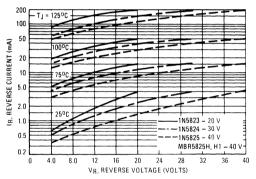


FIGURE 8 - MAXIMUM SURGE CAPABILITY



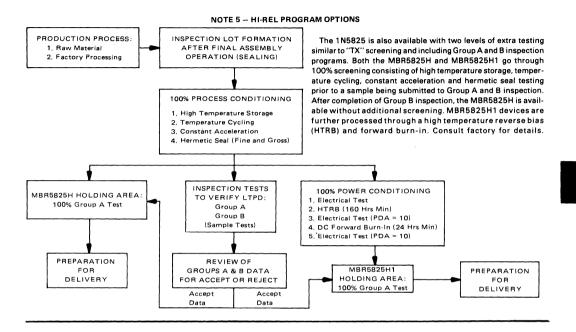




NOTE 4 -- HIGH FREQUENCY OPERATION

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 10).

Rectification efficiency measurements show that operation will be satisfactory up to several megahertz. For example, relative waveform rectification efficiency is approximately 70 per cent at 2.0 MHz, e.g., the ratio of dc power to RMS power in the load is 0.28 at this frequency, whereas perfect rectification would yield 0.406 for sine wave inputs. However, in contrast to ordinary junction diodes, the loss in waveform efficiency is not indicative of power loss; it is simply a result of reverse current flow through the diode capacitance, which lowers the dc output voltage.



MECHANICAL CHARACTERISTICS

CASE: Welded, hermetically sealed construction. FINISH: All external surfaces corrosion-resistant and the terminal leads are readily solderable. WEIGHT: 2.4 grams (approximately). POLARITY: Cathode to case. MOUNTING POSITONS: Any

